

SMD INFRARED LED

HKEL-261C



Features

Small double-end package

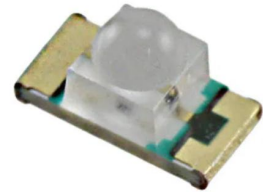
Low forward voltage

Good spectral matching to Si photo detector

Package in 8mm tape on 7" diameter reel.

Pb free

The product itself will remain within RoHS compliant version.



Application

PCB mounted infrared sensor

Infrared remote control units with high power requirement

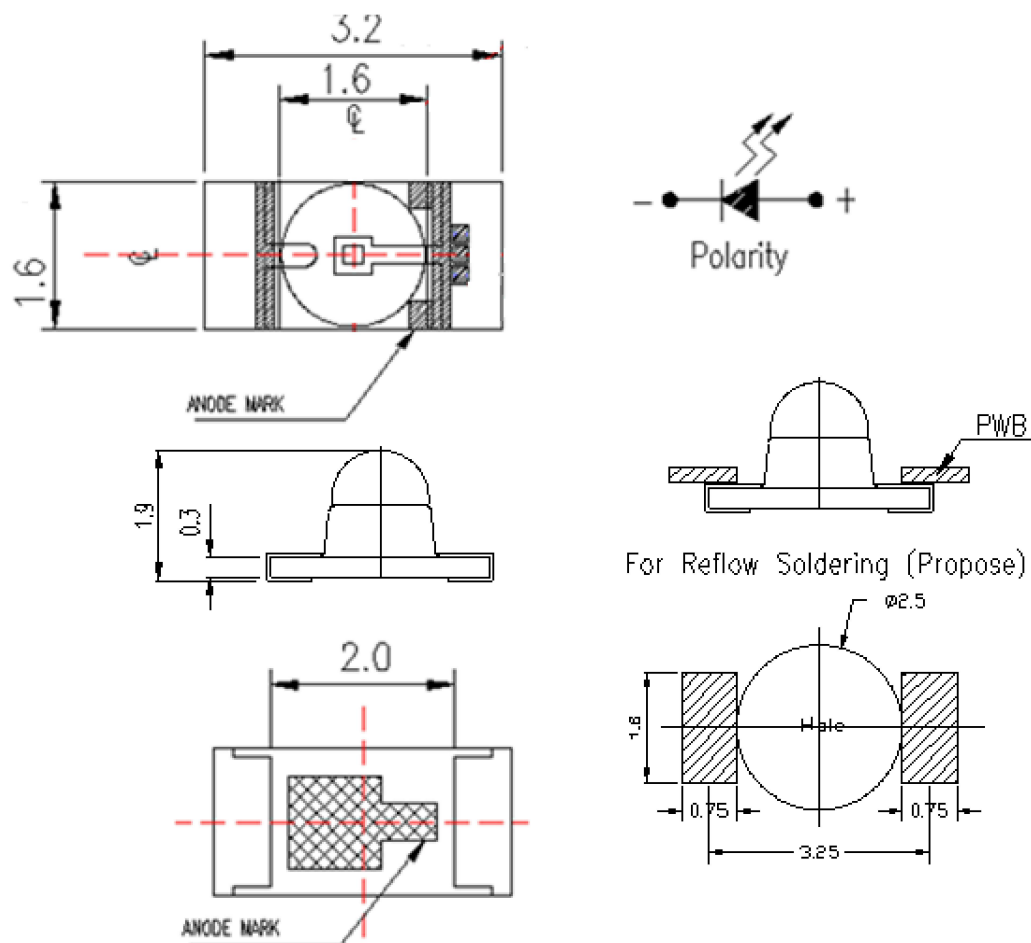
Scanner

Infrared applied system

Description

HKEL-261C is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens. The device is spectrally matched with silicon photodiode and phototransistor

PACKAGE DIMENSIONS



NOTES:

1. All dimensions are in millimeters
2. Tolerances unless dimensions $\pm 0.1\text{mm}$
3. Suggested pad dimension is just for reference only
Please modify the pad dimension based on individual need

ABSOLUTE MAXIMUM RATINGS AT TA =25°C

Parameter	Symbol	Rating	Units
Continuous Forward Current	I _F	65	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +85	°C
Soldering Temperature	T _{sol}	260	°C
Power Dissipation at(or below) 25°C Free Air Temperature	P _d	110	mW

Notes: *1 Soldering time ≤ 5 seconds.

ELECTRICAL OPTICAL CHARACTERISTICS AT TA=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Radiant Intensity	I _e	I _F =20mA	14.0	16.0	--	mW/sr
Peak Wavelength	λ _p	I _F =20mA	--	850	--	nm
Spectral Bandwidth	Δ λ	I _F =20mA	--	42	--	nm
Forward Voltage	V _F	I _F =20mA	--	1.45	1.70	V
Reverse Current	I _R	V _R =5V	--	--	10	μ A
Optical rise and fall time	t _r /t _f	I _F =50mA	--	25/15	35/35	ns
View Angle	2 θ 1/2	I _F =20mA	--	20	--	deg

Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs.
Ambient Temperature

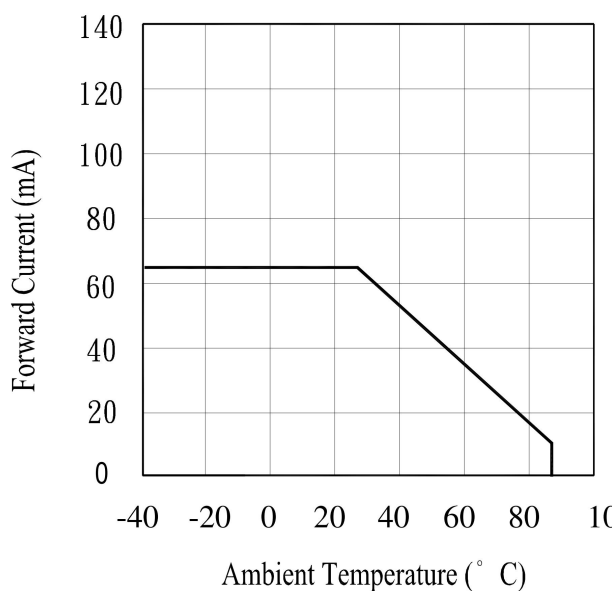


Fig.2 Spectral Distribution

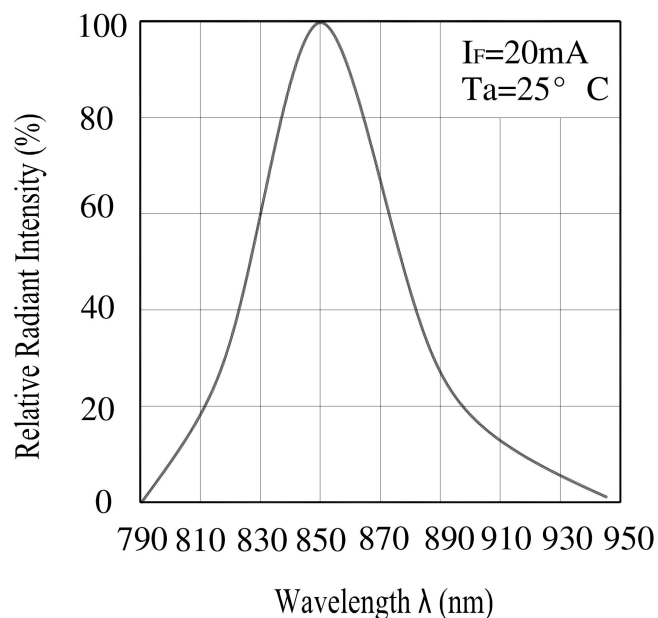


Fig.3 Peak Emission Wavelength
Ambient Temperature

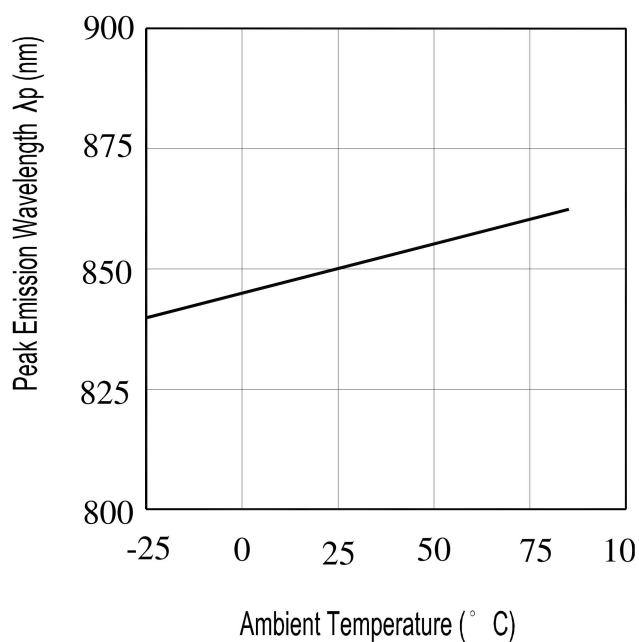
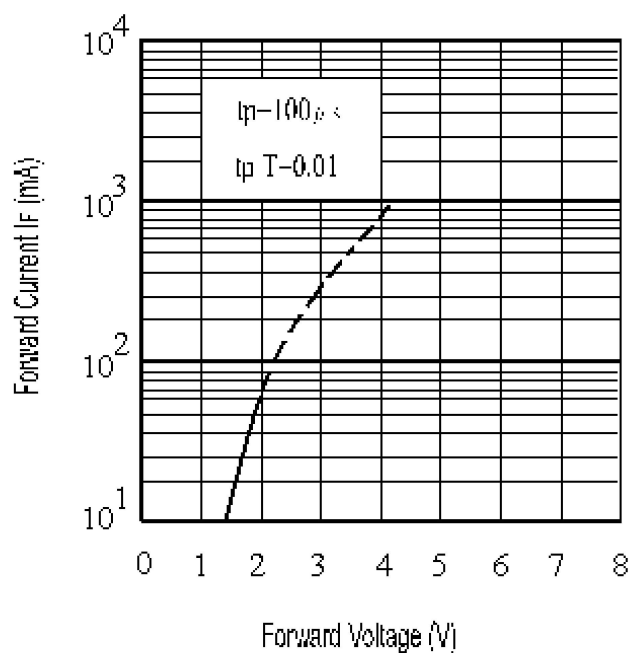


Fig.4 Forward Current
vs. Forward Voltage



Typical Electro-Optical Characteristics Curves

Fig.5 Radiant Intensity vs.

Angular Displacement

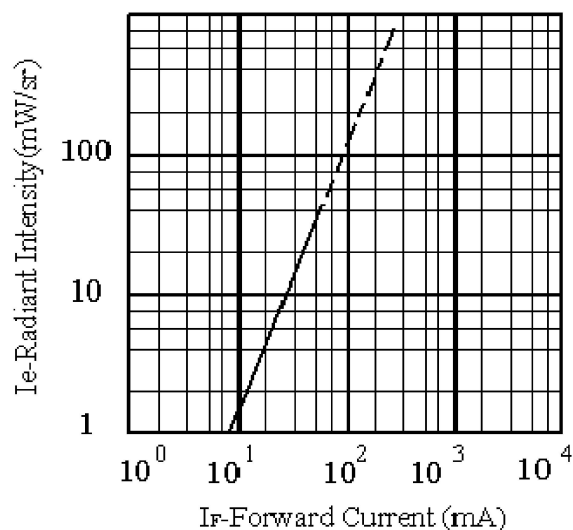
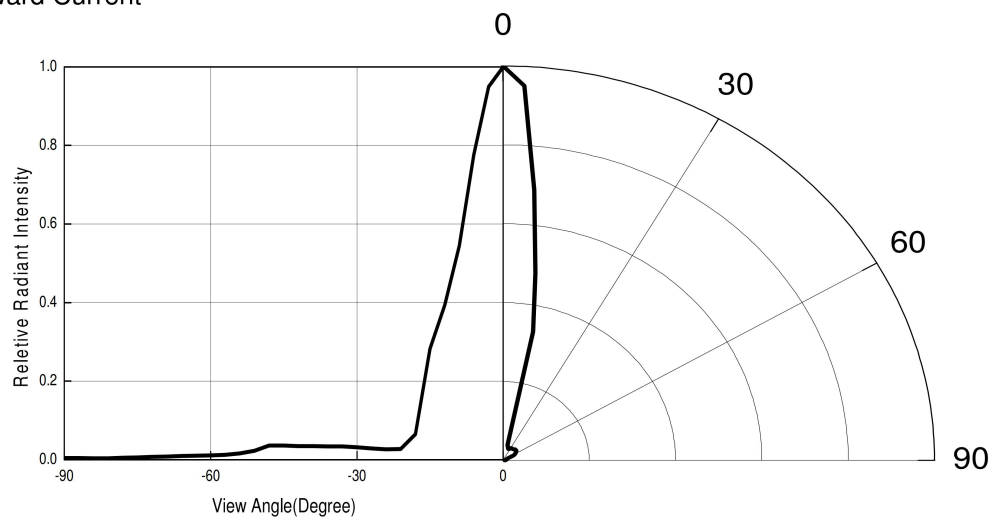


Fig.6 Relative Radiant Intensity vs.

Forward Current



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 10°C~30°C and 90%RH or less.

2.3 The LEDs suggested be used within one year.

2.4 After opening the package, the devices must be stored at 10°C~30°C and $\leq 60\%RH$, and used within 168 hours (floor life). If unused LEDs remain, it should be stored in moisture proof packages.

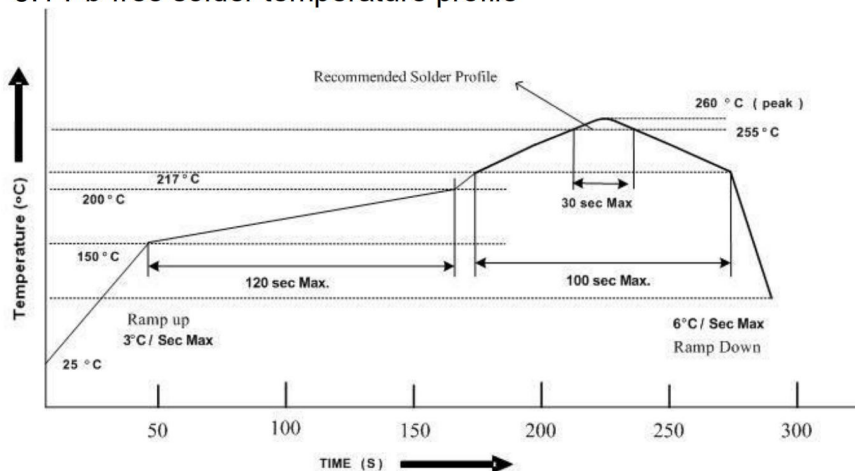
2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.

2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:

96 hours at 60°C $\pm$ 5°C and < 5 % RH (reeled/tubed/loose units)

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

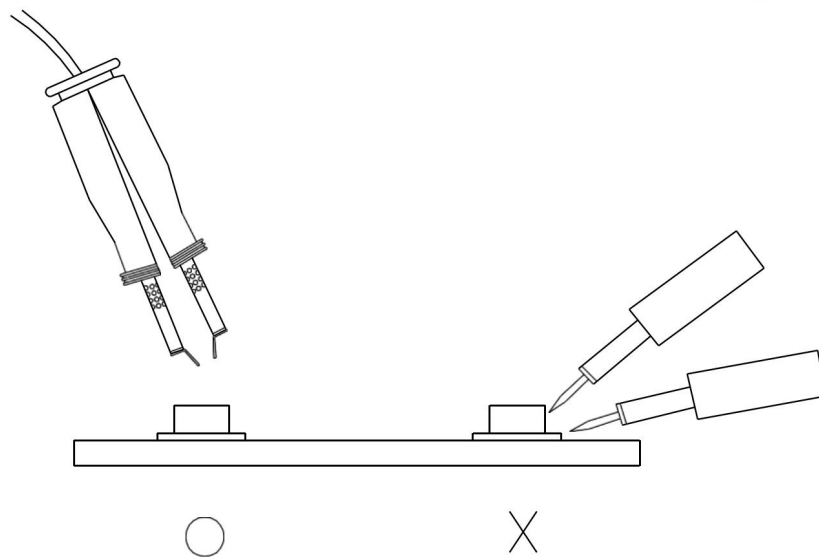
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

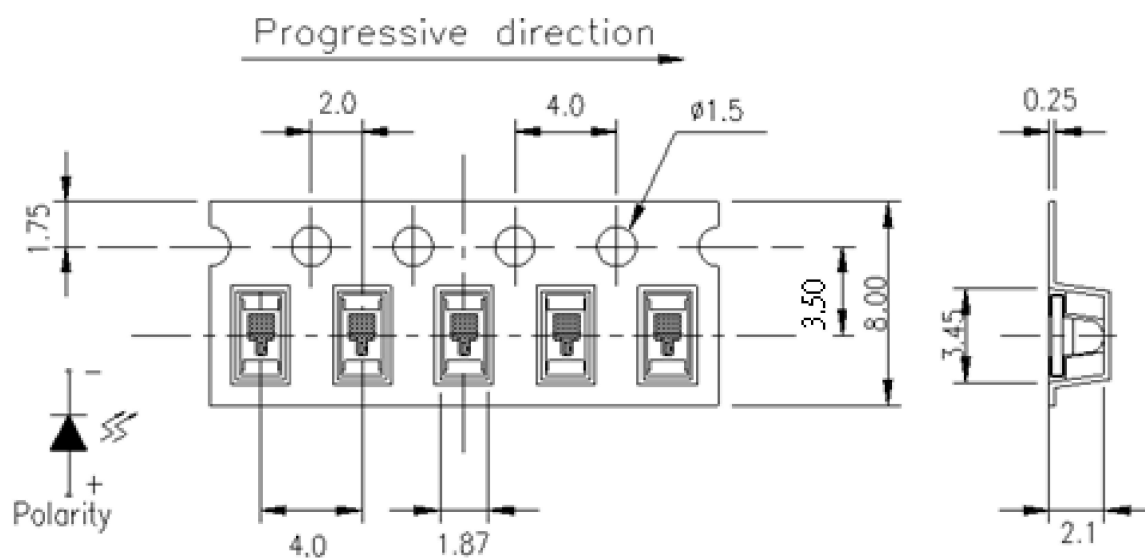
Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Carrier Tape Dimensions: Loaded quantity 1500 PCS per reel :



Packing Quantity Specification

1. 1500Pcs/1Reel,10 Bag/1Box
2. 4Boxes/1Carton

Label Form Specification

製品名 PRODUCT	
コードNo. CODE No.	
数 量 Q' TY	
ロットNo. LOT No.	
備 考 REMARKS	
	

- PRODUCT: Part Number
- CODE NO.: Product Serial Number
- QTY: Packing Quantity
- LOT No: Lot Number
- REMARKS:Remarks

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